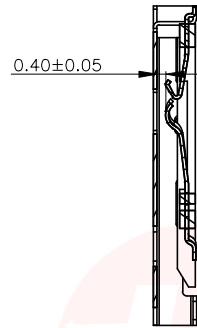
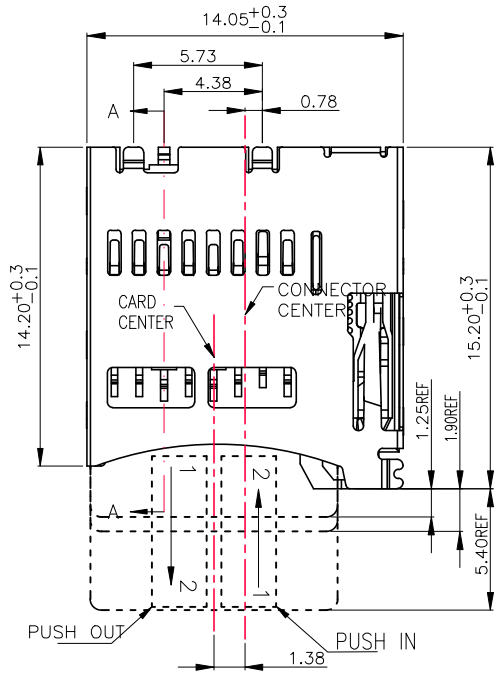
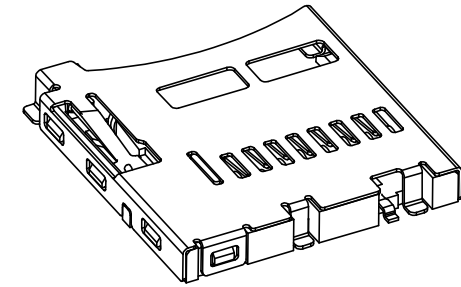
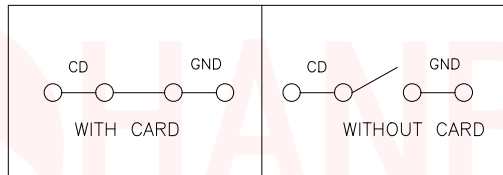
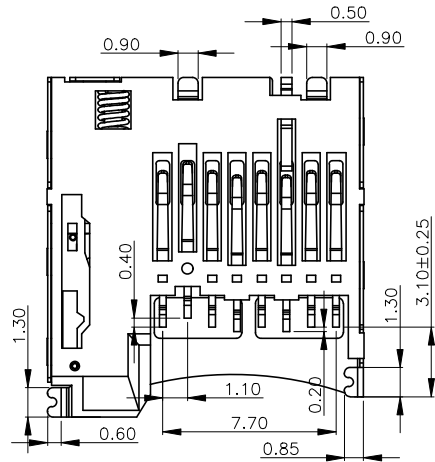




REV.	ECN NO OR DESCRIPTION	REVISED	DATE

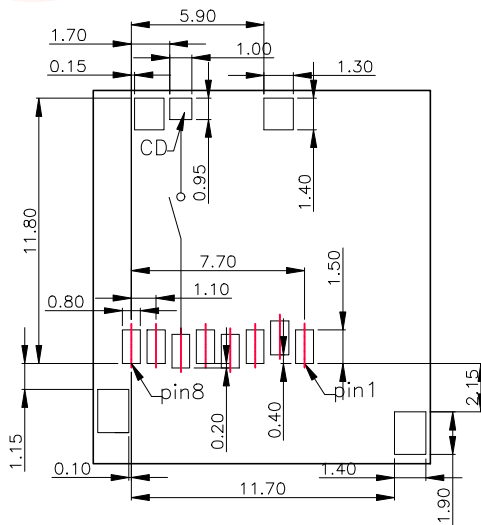


SECTION A-A

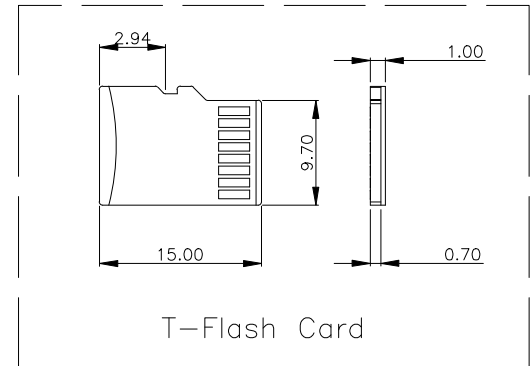


NOTES:

- MATERIAL:
HOUSING: HIGH TEMPERATURE THERMOPLASTIC UL94V_0,COLOR:BLACK.
CONTACT: COPPER ALLOYS.
COVER: COPPER ALLOYS OR STEEL.
- PLATING:
UNDERPLATE: NICKEL.
CONTACT AREA: GOLD OVER NICKEL.
SOLDER AREA: TIN OVER NICKEL.
- MULTIMEDIA CARD COMPATIBLE



RECOMMENDED P.C.B HOLE LAYOUT
COMPONENT SIDE VIEW(TOLERANCE: +/-0.05)



T-Flash Card

PIN NO.	NAME	YTYPE	DESCRIPTION
1	DAT2	I/O/PP	DATE LINE(BIT2)
2	CD/DAT3	I/O/PP	CARD DETECT DATE LIN(BIT3)
3	CMD	PP	COMMAND RESPONSE
4	VDD	S	SUPPLY VOLTAGE
5	CLX	I	CLOCK
6	VSS	S	SUPPLY VOLTAGE GROUND
7	DATO	I/O/PP	DATE LINE(BIT0)
8	DAT1	I/O/PP	DATE LINE(DIT1)
9	CD	CD	CD

UNLESS OTHERWISE SPECIFIED TOLERANCES

DECIMALS: X ±0.5 X.X ±0.20 X.XX ±0.10
 ANGLES: X ±2° X.X ±1°



东莞市汉博电子科技有限公司
DONGGUAN HANBO TECHNOLOGY CO., LTD

TITLE	T-FLASH CARD PUSH PUSH C TYPE 内焊		
DWN	xiong	TF-016-P3	
CHKD	lee	SCALE:1:1	UNIT: mm
APVD	wang	SIZE: A4	SHEET:10F 1
			REV: A4
CUSTOMER COPY			